

Electronic Patent Application Fee Transmittal

Application Number:	10823221			
Filing Date:	13-Apr-2004			
Title of Invention:	Integrated circuit devices having pad contact plugs in the cell array and peripheral circuit regions of the integrated circuit substrate and methods of forming the same			
First Named Inventor/Applicant Name:	Se-Hoon Oh			
Filer:	Elizabeth A. Stanek/Erin Dutton			
Attorney Docket Number:	5649-1228			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	790	790
Total in USD (\$)				790